μESD3.3ST5G SERIES

ESD Protection Diodes

In Ultra Small SOD-723 Package

The μESD Series is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium.

Specification Features:

• Small Body Outline Dimensions: 0.055" x 0.024" (1.40 mm x 0.60 mm)

Low Body Height: 0.020" (0.5 mm)
Stand-off Voltage: 3.3 V - 12 V

• Low Leakage

• Response Time is Typically < 1 ns

• ESD Rating of Class 3 (> 16 kV) per Human Body Model

IEC61000-4-2 Level 4 ESD Protection
IEC61000-4-4 Level 4 EFT Protection

• These are Pb-Free Devices

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic

Epoxy Meets UL 94 V-0

LEAD FINISH: 100% Matte Sn (Tin)

MOUNTING POSITION: Any

QUALIFIED MAX REFLOW TEMPERATURE: 260°C

Device Meets MSL 1 Requirements

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Air Contact		±30 ±30	kV
IEC 61000-4-4 (EFT)		40	Α
ESD Voltage Per Human Body Model Per Machine Model		16 400	kV V
Total Power Dissipation on FR-5 Board (Note 1) @ T _A = 25°C	P _D	150	mW
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
Lead Solder Temperature - Maximum (10 Second Duration)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. $FR-5 = 1.0 \times 0.75 \times 0.62$ in.



ON Semiconductor®

http://onsemi.com



PIN 1. CATHODE 2. ANODE



SOD-723 CASE 509AA





XX = Specific Device Code

M = Date Code ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
μESDxxST5G	SOD-723 (Pb-Free)	8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DEVICE MARKING INFORMATION

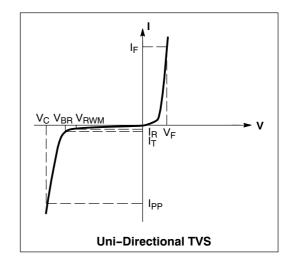
See specific marking information in the device marking column of the table on page 2 of this data sheet.

μESD3.3ST5G SERIES

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

	<u> </u>
Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ IPP
V_{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V_{BR}	Breakdown Voltage @ I _T
Ι _Τ	Test Current
I _F	Forward Current
V_{F}	Forward Voltage @ I _F
P _{pk}	Peak Power Dissipation
С	Max. Capacitance @V _R = 0 and f = 1 MHz



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 1.1$ V Max. @ $I_F = 10$ mA for all types)

	Device	V _{RWM} (V)	I _R (μΑ) @ V _{RWM}	V _{BR} (V) @ I _T (Note 2)	I _T	V _C (V) @ Max I _{PP} †	I _{PP} (A) [†]	P _{pk} (W) [†]	C (pF)
Device*	Marking	Max	Max	Min	mA	Max	Max	Max	Тур
μESD3.3ST5G	E0	3.3	2.5	5.0	1.0	10.9	10.4	113	80
μESD5.0ST5G	E2	5.0	1.0	6.2	1.0	13.3	8.8	117	65
μESD12ST5G	E3	12	1.0	13.5	1.0	23.7	5.4	128	30

^{*}Other voltages available upon request.

[†]Surge current waveform per Figure 1.
2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

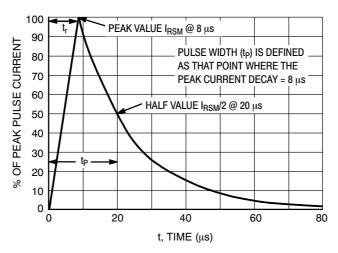


Figure 1. 8 x 20 µs Pulse Waveform

μESD3.3ST5G SERIES

TYPICAL CHARACTERISTICS

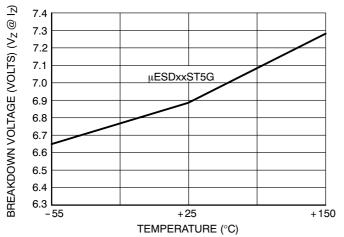


Figure 2. Typical Breakdown Voltage versus Temperature

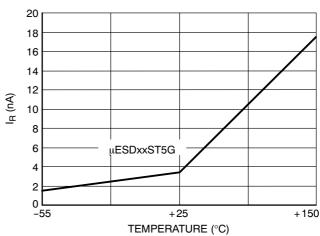


Figure 3. Typical Leakage Current versus Temperature

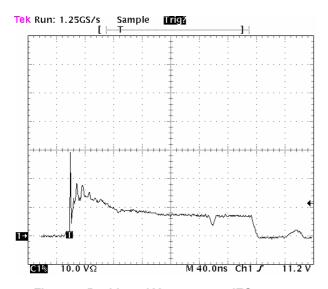


Figure 4. Positive 8 kV contact per IEC 6100-4-2 - μESD5.0ST5G

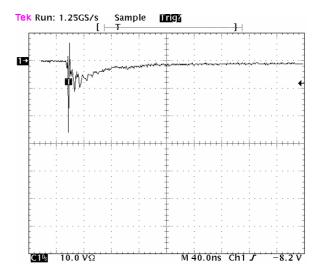


Figure 5. Negative 8 kV contact per IEC 61000-4-2 $- \mu$ ESD5.0ST5G





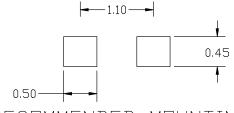
SOD-723, 2-LEAD, 1.00x0.60x0.52 CASE 509AA ISSUE A

DATE 01 FEB 2024

NOTES:

- I. DIMENSIONSING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSIONS: MILLIMETER.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

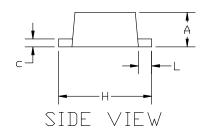
DIM	MILLIMETERS			
ויודת	MIN.	N□M.	MAX.	
А	0.49	0.52	0.55	
b	0.25	0.28	0.32	
С	0.08	0.12	0.15	
D	0.95	1.00	1.05	
E	0.55	0.60	0.65	
Н	1.35	1.40	1.45	
L	0.15	0.20	0.25	



RECOMMENDED MOUNTING FOOTPRINT

*For additional formation on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

-	D - E	B
ax p		E U
⊕ 0.08 A B T □ P	VIEW	



GENERIC MARKING DIAGRAM*



XX = Specific Device Code M = Date Code

DOCUMENT NUMBER:	98AON20359D	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOD-723, 2-LEAD, 1.00x0.60x0.52		PAGE 1 OF 1	

onsemi and ONSemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales